



AMENDMENTS TO THE SPECIFICATION

Please amend the title of the application to read as follows:

PROGRAMMABLE STRUCTURE, AN ARRAY INCLUDING THE STRUCTURE
AN OXIDE ELECTROLYTE, AND METHODS METHOD OF FORMING SAME
PROGRAMMABLE STRUCTURE

Please replace section CROSS REFERENCE TO RELATED APPLICATIONS with the following:

This application is a continuation-in-part of United States Patent Application Serial No. 10/390,268, entitled PROGRAMMABLE STRUCTURE, AN ARRAY INCLUDING THE STRUCTURE, AND METHODS OF FORMING THE SAME, filed March 17, 2003, which is a continuation-in-part of United States Patent Application Serial No. 10/268,107, entitled PROGRAMMABLE MICROELECTRONIC DEVICE, STRUCTURE, AND SYSTEM AND METHOD OF FORMING THE SAME, filed October 9, 2002, which is a continuation-in-part of Application Serial No. 10/118,276 entitled MICROELECTRONIC DEVICE, STRUCTURE, AND SYSTEM, INCLUDING A MEMORY STRUCTURE HAVING A VARIABLE PROGRAMMABLE PROPERTY AND METHOD OF FORMING SAME, filed April 9 8, 2002, which is a continuation-in-part of Application Serial No. 09/502,915, entitled PROGRAMMABLE MICROELECTRONIC DEVICES AND METHODS OF FORMING AND PROGRAMMING SAME, filed April 19 Feb. 11, 2000; and is a continuation-in-part of United States Patent Application Serial No. 09/951,882, entitled MICROELECTRONIC PROGRAMMABLE DEVICE AND METHODS OF FORMING AND PROGRAMMING THE SAME, filed September 10, 2001; and claims the benefit of United States Patent Application Serial No. 60/452,648, entitled FABRICATION OF PROGRAMMABLE METALLIZATION CELL DEVICES WITH OXIDE ELECTROLYTES, filed March 7, 2003; United States Patent Application Serial No. 60/364,547, entitled PASSIVE MEMORY ARRAYS USING THE PROGRAMMABLE METALLIZATION CELL, filed March 15, 2002; United States Patent Application Serial No. 60/365,551, entitled PULSE MODE PROGRAMMABLE METALLIZATION CELL (PMPMC) TECHNOLOGY, filed March 18, 2002; United States Patent Application Serial No. 60/365,602, entitled METHOD AND APPARATUS TO

INCREASE SPEED OF ELECTRODEPOSIT FORMATION AND ELECTRODEPOSIT DENSITY IN PROGRAMMABLE METALLIZATION CELL DEVICES, filed March 18, 2002; and United States Patent Application Serial No. 60/365,601, entitled PROGRAMMABLE METALLIZATION CELL MATERIALS, STRUCTURES AND DEVICES, filed March 18, 2002.